

## **IEEE Region 10 Industry Relations Committee Student Travel Fund (IRC-STF)**

(Application Deadline **15<sup>th</sup> June 2019**)

IEEE Region 10 Industry Relations Committee (IRC) student travel Fund is willing to provide financial assistance to IEEE Student members to enrich their exposure and experience for industry engagement, which includes but is not limited to:

- Participating in Industry Forums and related industry/entrepreneur sessions organized by IRC (required to receive IRC-STF)
- Participating in full conference
- Presenting at a conference
- Acquiring new knowledge that benefits the applicant's academic/Research work

### **ELIGIBILITY**

1. Travel Funding is available to all IEEE Region 10 Student Members registered as a full time Bachelor, Master or Ph.D. student in engineering or a related field in a college or university
2. Students are eligible to receive up to a maximum of \$300

### **FUNDING CONDITIONS**

1. This Funding is only applicable to students who are confirmed to attend the Industry Forum and related industry/entrepreneur sessions organized by IRC in one of the following Conferences happening in IEEE Region 10:
  - a. ISCAS (May 26-29, Sapporo, Japan) Industry Forum
  - b. ICCE Asia (June 12-14, Bangkok, Thailand) Industry Forum
  - c. TEMS India (Sept. Bangalore, India) Matchup
  - d. TENCON (Oct. 17-20, Kerala, India) Industry Forum & Matchup
  - e. TEMS ISIE (Oct. 24-26, Hangzhou, China) Industry Forum & Matchup
  - f. HTC (Nov. 12-14, Depok, Indonesia) Industry Forum
  - g. VCIP (Dec. 1-4, Sydney, Australia) Industry Forum
2. Each applicant must submit an individual request application after the mandatory due endorsement/recommendation from the Chair of Student Activity committee of the parent IEEE Section at least two weeks before the conference dates (unless otherwise approved by the IRC SFRC under special circumstances) as stipulated above.
3. Applications will be reviewed by IRC Student Funding Review Committee (SFRC) members based on the following criterion:
  - a. Evidence of student's leadership/strength in contests and/or industry/entrepreneur related activities, (e.g. hackathon, business planning, pitching or design contests, etc.).
  - b. Records of internship or experiences with industry/entrepreneur related projects.

- c. Endorsement/Recommendation provided by respective IEEE Student Activity Chairs with preferences to students actively promoting IEEE activities (e.g. Industry Forum and related industry/entrepreneur sessions organized by IRC mentioned above)
4. Following shall be part of application (Name, Full contact details with Email Ids and Contact Numbers with Emergency Contacts, Current Status of Students – UG/PG/PhD along with a paragraph not more than 250 words mentioning How this travel support will help the student in their Studies/Technical or Professional development) – **Complete your Application online** <https://bitlylink.com/yK6ow>
5. Due to limited funds, not all requests that meet the established criteria will be approved. We process all applications on a first come, first-served basis until all program funds are expended.
6. Funding payment will be transferred to respective IEEE sections after the conference has ended with an instruction to transfer to beneficiaries.

#### **OBLIGATIONS UPON APPROVAL OF FUNDING**

1. Funding transfers will only be issued after the conference has officially ended and beneficiary has attended the Industry Forum or related industry sessions of respective conference.
2. Funding disbursement are provided on an expense reimbursement basis. (Receipts must be submitted to respective sections before payment is made).
3. If receipts provided total is less than the original funding amount, then the funding amount will be changed accordingly.

#### **RESTRICTIONS**

1. IRC will provide funding for accommodation, delegate or conference fees, and travel to and from the conference.
2. Applicants who receive alternate funding from other IEEE Entities for the same travel and/or conference being applied for are not eligible for funding.
3. Applicants who are receiving any wage or honorarium for their attendance at the conference are not eligible for funding.
4. Same person cannot avail travel support for more than one Conference.

Kindly email the SFRC Chair, Dr. Amit Kumar ([amitkr@ieee.org](mailto:amitkr@ieee.org)) or Ms. Ewell Tan ([ewell.tan@ieee.org](mailto:ewell.tan@ieee.org)) for inquiries.